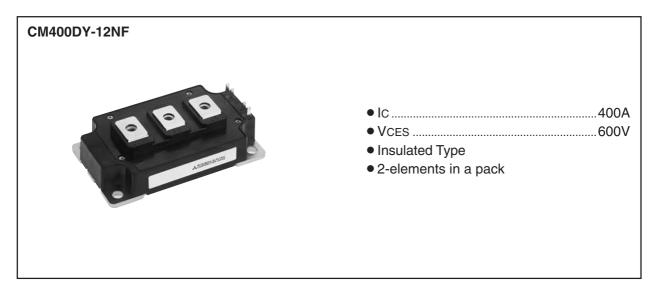
MITSUBISHI IGBT MODULES

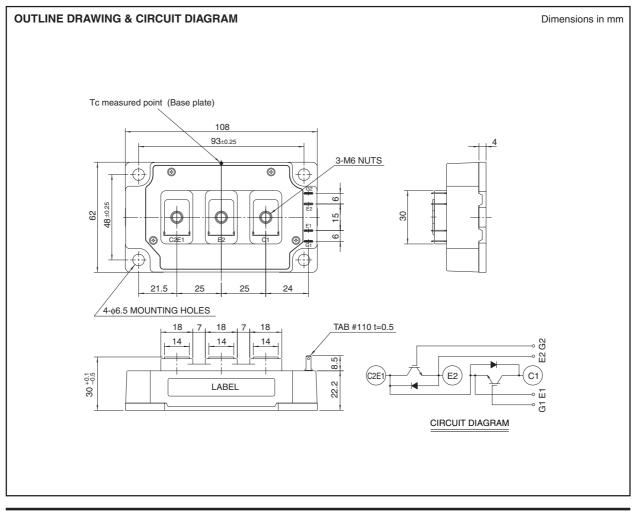
# CM400DY-12NF

HIGH POWER SWITCHING USE



### **APPLICATION**

General purpose inverters & Servo controls, etc





# **CM400DY-12NF**

#### **HIGH POWER SWITCHING USE**

#### MAXIMUM RATINGS (Tj = 25°C, unless otherwise specified)

| Symbol       | Parameter                     | Conditions                                  |          | Ratings    | Unit  |
|--------------|-------------------------------|---|----------|------------|-------|
| VCES         | Collector-emitter voltage     | G-E Short                                   |          | 600        | V     |
| VGES         | Gate-emitter voltage          | C-E Short                                   |          | ±20        | V     |
| IC           | Collector current             | DC, Tc' = $92^{\circ}C^{*3}$                |          | 400        | A     |
| Ісм          | Collector current             | Pulse                                       | (Note 2) | 800        | A     |
| IE (Note 1)  | Emitter current               |   |          | 400        | A     |
| IEM (Note 1) | Emilier current               | Pulse                                       | (Note 2) | 800        | A     |
| PC (Note 3)  | Maximum collector dissipation | $Tc = 25^{\circ}C$                          |          | 1130       | W     |
| Tj           | Junction temperature          |   |          | -40 ~ +150 | °C    |
| Tstg         | Storage temperature           |   |          | -40 ~ +125 | °C    |
| Viso         | Isolation voltage             | Terminals to base plate, f = 60Hz, AC 1 min | ute      | 2500       | Vrms  |
| _            | To make a two weaths          | Main terminals M6 screw                     |          | 3.5 ~ 4.5  | N • m |
| _            | Torque strength               | Mounting M6 screw                           |          | 3.5 ~ 4.5  | N • m |
| _            | Weight                        | Typical value                               |          | 400        | g     |

#### ELECTRICAL CHARACTERISTICS (Tj = 25°C, unless otherwise specified)

| O male al    | Parameter                            | Test conditions   |            | Limits |      |                     | 1.1  |
|--------------|--------------------------------------|---|------------|--------|------|---------------------|------|
| Symbol       | Parameter                            |   |            | Min.   | Тур. | Max.                | Unit |
| ICES         | Collector cutoff current             | VCE = VCES, VGE = 0V  |            | —      | —    | 1                   | mA   |
| VGE(th)      | Gate-emitter threshold voltage       | IC = 40mA, VCE = 10V  |            | 5      | 6    | 7.5                 | v    |
| IGES         | Gate leakage current                 | $\pm$ VGE = VGES, VCE = 0V  |            |        | _    | 0.5                 | μA   |
| VCE(sat)     | Collector-emitter saturation voltage | IC = 400A, VGE = 15V  | Tj = 25°C  | _      | 1.7  | 2.2                 | V    |
|              |                                      |   | Tj = 125°C | _      | 1.7  | _                   |      |
| Cies         | Input capacitance                    | VCE = 10V<br>VGE = 0V   |            | _      | —    | 60                  | nF   |
| Coes         | Output capacitance                   |   |            | _      | —    | 7.3                 | nF   |
| Cres         | Reverse transfer capacitance         |   |            | _      | _    | 2.4                 | nF   |
| QG           | Total gate charge                    | VCC = 300V, IC = 400A, VGE = 15V  |            | _      | 1600 | _                   | nC   |
| td(on)       | Turn-on delay time                   | Vcc = 300V, lc = 400A<br>VGE = $\pm 15V$<br>RG = 3.1 $\Omega$ , Inductive load<br>IE = 400A |            | _      | _    | 300                 | ns   |
| tr           | Turn-on rise time                    |   |            | _      | _    | 200                 | ns   |
| td(off)      | Turn-off delay time                  |   |            | _      | _    | 450                 | ns   |
| tf           | Turn-off fall time                   |   |            | _      | _    | 300                 | ns   |
| trr (Note 1) | Reverse recovery time                |   |            | _      |      | 250                 | ns   |
| Qrr (Note 1) | Reverse recovery charge              |   |            | _      | 6.8  | —                   | μC   |
| VEC(Note 1)  | Emitter-collector voltage            | IE = 400A, VGE = 0V   |            | _      | —    | 2.6                 | V    |
| Rth(j-c)Q    | - Thermal resistance <sup>*1</sup>   | IGBT part (1/2 module)  |            | _      | _    | 0.11                | K/W  |
| Rth(j-c)R    |                                      | FWDi part (1/2 module)  |            | _      | —    | 0.19                | K/W  |
| Rth(c-f)     | Contact thermal resistance           | Case to heat sink, Thermal compound Applied <sup>*2</sup> (1/2 module)                      |            | _      | 0.04 | —                   | K/W  |
| Rth(j-c')Q   | Thermal resistance                   | Case temperature measured point is just under the chips                                     |            | _      |      | 0.066 <sup>*3</sup> | K/W  |
| RG           | External gate resistance             |   |            | 1.6    | _    | 16                  | Ω    |

\*1 : Case temperature (Tc) measured point is shown in page OUTLINE DRAWING.
\*2 : Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m • K)].
\*3 : Case temperature (Tc') measured point is just under the chips.

If you use this value, Rth(f-a) should be measured just under the chips.

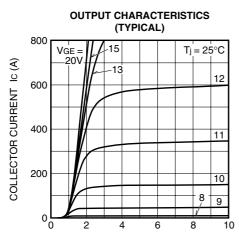
Note 1. IE, VEC, tr & Qrr represent characteristics of the anti-parallel, emitter-collector free-wheel diode (FWDi).
2. Pulse width and repetition rate should be such that the device junction temperature (Tj) does not exceed Tjmax rating.
3. Junction temperature (Tj) should not increase beyond 150°C.



### **CM400DY-12NF**

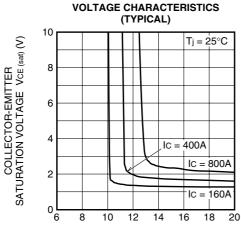
#### **HIGH POWER SWITCHING USE**

#### PERFORMANCE CURVES

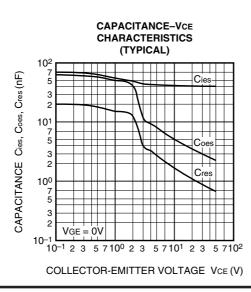


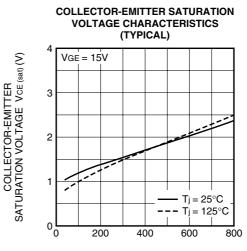
COLLECTOR-EMITTER VOLTAGE VCE (V)

**COLLECTOR-EMITTER SATURATION** 



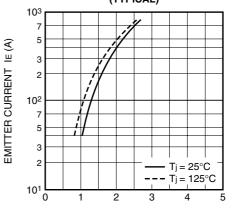
GATE-EMITTER VOLTAGE VGE (V)



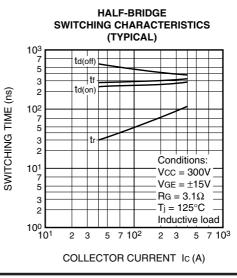


COLLECTOR CURRENT Ic (A)

FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



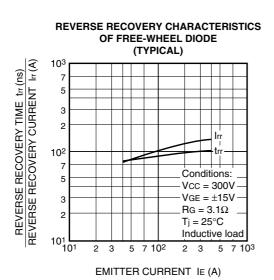
EMITTER-COLLECTOR VOLTAGE VEC (V)



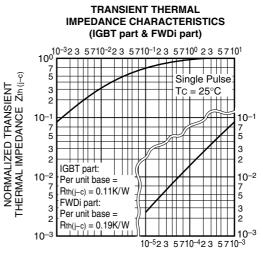


## CM400DY-12NF

#### **HIGH POWER SWITCHING USE**



GATE CHARGE CHARACTERISTICS (TYPICAL) 20 IC = 400A GATE-EMITTER VOLTAGE VGE (V) Vcc = 200V 16 Vcc = 300V12 8 4 0 500 1000 1500 2000 2500 GATE CHARGE QG (nC)



TIME (s)



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